OV13870 13MP product brief





13-Megapixel PureCel®Plus-S Sensor for High-End Mobile Applications

available in a lead-free package

OmniVision's OV13870 is the industry's first 13-megapixel "big pixel" sensor capable of recording full-resolution 1080p high definition (HD) video at 240 frames per second (fps). The OV13870 also features a 12-bit analog to digital converter (ADC) to enable better low light signal to noise ratio (SNR), phase detection auto focus (PDAF), and dedicated support for dual-camera functionality.

Built on OmniVision's new PureCel Plus-S pixel architecture, the OV13870 delivers best-in-class pixel performance with significant improvements in low-light performance and crosstalk reduction with minimal chip size. Even with a 1/2.74-inch optical format, the OV13870 has an extremely compact module with a z-height of about 5.5 mm.

The OV13870 can capture full-resolution 13-megapixel still images at 45 fps or record ultra-high resolution 4K2K video at 60 fps, 1080p full HD at 240 fps.

Find out more at www.ovt.com.





Applications

- Smartphones
- Tablets

PC Multimedia

Product Features

- 1.25 µm x 1.25 µm pixel
- optical size of 1/2.74"
- 33.99° CRA
- enhanced dual cam support
- high-speed architecture for fast frames per second (fps)
- programmable controls for frame rate, mirror and flip, cropping, and windowing
- supports images sizes: - 13MP (4224x3136) - 4K2K (3840x2160) - 1080p (1920x1080), and more
- two-wire serial bus control (SCCB)
- strobe output to control flash

- embedded 13.5 kbits of one-time programmable (OTP) memory
- support for phase detection auto focus (PDAF)
- two on-chip phase lock loops (PLLs)
- programmable controls for gain, exposure, frame rate, image size, horizontal mirror, vertical flip, cropping, and panning
- image quality controls for:
 defect pixel correction - automatic black level calibration - lens shading correction - alternate row HDR
- built-in temperature sensor
- typical module size: 9.5 x 9.5 x <5.55 mm

- OV13870-GA5A-Z
- (color, chip probing, 150 µm backgrinding, reconstructed wafer with good die)

Product Specifications

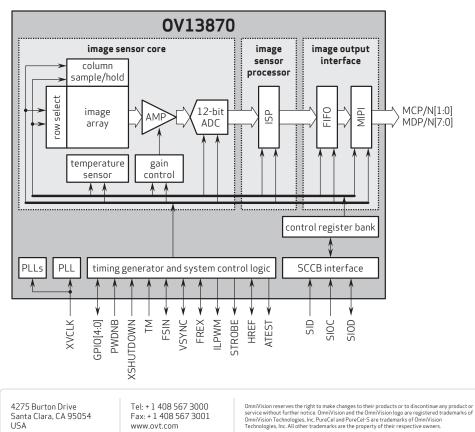
- active array size: 4224 x 3136
- power supply:
- core: 1.2V analog: 2.8V I/O: 1.8V
- power requirements: active: 320 mW @ full-res, 30 fps, 12-bit sensitivity: 4800 e /lux-sec - standby: 265 mW @ full-res, 30 fps, 10-bit
 - XSHUTDOWN: <10 µW
- temperature range:
 operating: -30°C to +85°C junction temperature stable image: 0°C to +60°C junction
- temperature
- output formats: 12/10-bit RGB RAW, DPCM 12-8 compression
- lens size: 1/2.74"
- lens chief ray angle: 33.99° non-linear

■ input clock frequency: 6 - 27 MHz

OV13870

- maximum image transfer rate:
- 13MP (10-bit) (4:3): 45 fps 13MP (12-bit) (4:3): 30 fps 4K2K (16:9): 60 fps
- 1080p FHD (crop+bin): 240 fps
- max S/N ratio: 37.7 dB
- dynamic range: 72.3 dB @ 8x gain
- scan mode: progressive
- **pixel size:** 1.25 μm x 1.25 μm
- dark current: 2 e⁻/sec @ 60°C junction temperature
- image area: 5320 μm x 3960 μm
- die dimensions: - COB: 6300 μm x 4900 μm - RW: 6350 μm x 4950 μm

Functional Block Diagram





Version 1.2, August, 2016